

03-28-2005

FORM PTO-1595

RECOR

U.S. DEPARTMENT OF COMMERCE

(Rev. 6-93)

OMB No. 0651-0011 (exp. 4/94)

Tab settings →→→



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Patent and Trademark Office

To the Honorable Commissioner for Patents : Please record the attached original documents or copy thereof.

Name of conveying party(ies):

1. Thorsten Schedel
2. Torsten Seidl

(Additional name(s) of conveying party(ies) attached) Yes ☒ No

2. Nature of conveyance:

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Other

Execution Date: May 5, 2003 for 1, April 30, 2003 for 2.

1. Name and address of receiving party(ies):

Name: Infineon Technologies SC300 GmbH & Co. KGStreet Address: Königsbrücker Strasse 180City: DresdenState: GermanyZIP: 01099Additional name(s) & address(es) attached ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is

A. Patent Application No.(s)

10/435,449

B. Patent No.(s)

Additional numbers attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lerner and Greenberg

Internal Address:

Street Address: P.O. Box 2480City: HollywoodState: FLZIP: 33022

6. Total number of applications and patents involved:

17. Total fee (37 CFR 3.41)\$ 40.00

- ☒ Enclosed
- ☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page by deposit account)

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*RALPH E. LOCHER
REG. NO. 41,947

Name of Person Signing

Signature

March 22, 2005

Date

Total number of pages including cover sheet, attachments, and document:

3

03/25/2005 ECDOPER 00000305 10435449

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40.00 OP

PATENT
REEL: 016389 FRAME: 0691

Docket No.: P2000,0267

ASSIGNMENT

WHEREAS WE, THORSTEN SCHEDEL and TORSTEN SEIDEL, respectively residing at DRESDEN and OHORN, Germany, have invented certain new and useful improvements in a

METHOD FOR EXPOSING A SEMICONDUCTOR WAFER

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

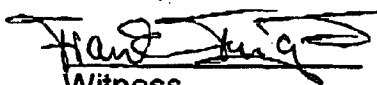
WHEREAS, INFINEON TECHNOLOGIES SC300 GMBH & CO. KG, a German limited liability company doing business at Dresden, Germany, is desirous of acquiring the entire interest in the invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of our employment by the the company and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the the company, its legal representatives, successors and assigns, the full and exclusive right to the the invention as fully set forth and described in the above-mentioned application, and to the application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of the Letters Patent, the same to be held and enjoyed by the the company, its legal representatives, successors and assigns, to the full end of the term for which the Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

AND WE hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on the invention or resulting from the Application and from any and all divisions and continuations thereof to the the company as the assignee of the entire right, title and interest in and to the same.

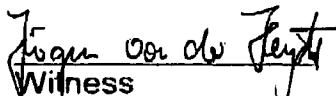
IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:


Witness


THORSTEN SCHEDEL (LS)

Date: 5 May 2003


Witness

TORSTEN SEIDEL (LS)

Date: _____

Docket No.: P2000,0267

ASSIGNMENT

WHEREAS WE, THORSTEN SCHEDEL and TORSTEN SEIDEL, respectively residing at DRESDEN and OHORN, Germany, have invented certain new and useful improvements in a

METHOD FOR EXPOSING A SEMICONDUCTOR WAFER

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, INFINEON TECHNOLOGIES SC300 GMBH & CO. KG, a German limited liability company doing business at Dresden, Germany, is desirous of acquiring the entire interest in the invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of our employment by the the company and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the the company, its legal representatives, successors and assigns, the full and exclusive right to the the invention as fully set forth and described in the above-mentioned application, and to the application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of the Letters Patent, the same to be held and enjoyed by the the company, its legal representatives, successors and assigns, to the full end of the term for which the Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

AND WE hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on the invention or resulting from the Application and from any and all divisions and continuations thereof to the the company as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:

E. L. H. H. H.
Witness

T. J. H. H. H.
Witness

THORSTEN SCHEDEL (LS)

Date: _____

TORSTEN SEIDEL (LS)

Date: 30. April 2003